

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2143	438/455.ccls. 438/458.ccls. 438/459.ccls. 438/977.ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/04 08:52
L2	3	((wafer substrate) with (thinn\$4 delaminat\$6)) and (embrittle\$6 smartcut eltran cleav\$5) and implant\$7	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/04 08:53
L3	121	((438/455.ccls. 438/458.ccls. 438/459.ccls. 438/977.ccls.) and (embrittle\$6 implant\$7 smartcut eltran cleav\$5)) and (polymer ether arylene ketone acetylene naphthylene polyarylene)	US-PGPUB; USPAT	OR	ON	2005/03/04 09:01
L4	161	(438/455.ccls. 438/458.ccls. 438/459.ccls. 438/977.ccls.) and ((embrittle\$6 smartcut eltran cleav\$5) same implant\$7)	US-PGPUB; USPAT	OR	ON	2005/03/04 10:19
L5	8	((((wafer substrate) with (thinn\$4 delaminat\$6)) and (embrittle\$6 implant\$7 smartcut eltran cleav\$5)) and (polymer ether arylene ketone acetylene naphthylene polyarylene)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/04 10:49
L6	24	((wafer substrate) with (thinn\$4 delaminat\$6)) and (embrittle\$6 smartcut eltran cleav\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/04 10:50
L7	167	((wafer substrate) with (thinn\$4 delaminat\$6)) and ((embrittle\$6 smartcut eltran cleav\$5) same implant\$7)	US-PGPUB; USPAT	OR	ON	2005/03/04 10:54
L8	226	((((wafer substrate) with (thinn\$4 delaminat\$6)) and (embrittle\$6 implant\$7 smartcut eltran cleav\$5)) and ((polymer ether arylene ketone acetylene naphthylene polyarylene) same (handle transfer))	US-PGPUB; USPAT	OR	ON	2005/03/04 11:36
L9	225	((wafer substrate) with (thinn\$4 delaminat\$6)) same (embrittle\$6 implant\$7 smartcut eltran cleav\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/04 11:58
L10	2	epoxy with polyimide with outgas\$5	US-PGPUB; USPAT	OR	ON	2005/03/04 12:05
L11	20	polyimide with outgas\$5 with cur\$4	US-PGPUB; USPAT	OR	ON	2005/03/04 12:06
L12	192	epoxy with polyimide with adhesive with (alcohol ether ketone)	US-PGPUB; USPAT	OR	ON	2005/03/04 12:07